

REAL TIME CLOCK MODULE (SPI-Bus)
 High-Stability Frequency with Built in Timestamp and Power Switching



Product Number
RX-4035SA B: X1B000192000100
RX-4035SA AC: X1B000192000200
RX-4035SA AA: X1B000192000300
RX-4035LC B: X1B000202000100
RX-4035LC AC: X1B000202000200
RX-4035LC AA: X1B000202000300

RX-4035SA / LC

- Built-in 32.768 kHz crystal unit : Frequency adjusted for high accuracy. ($\pm 5 \times 10^{-6} / T_a = +25^\circ\text{C}$)
- Interface Type : SPI-Bus (1MHz)
- Operating voltage range : 2.4 V to 5.5 V
- Timekeeping voltage range : 1.0 V to 5.5 V
- Low backup current : 350 nA (SA) 400 nA (LC) / 3 V (Typ.)
- Event detection and Time stamp : One-shot full timestamp and interrupt.
- Dual event detection ports : Each terminal has a de-bounce circuit.
- Auto power switching functions : When VDD deteriorates than 2.4V, internal source is switched to VBAT.

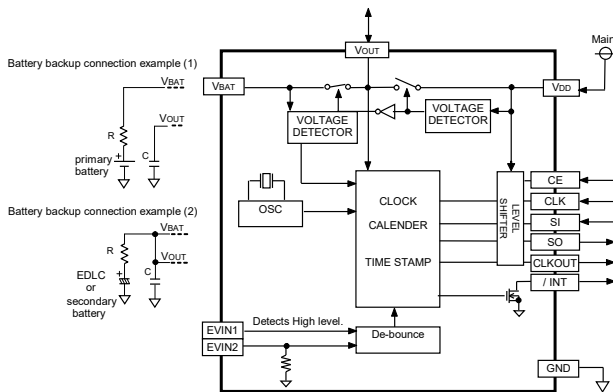


RX-4035SA



RX-4035LC

Block diagram



Overview

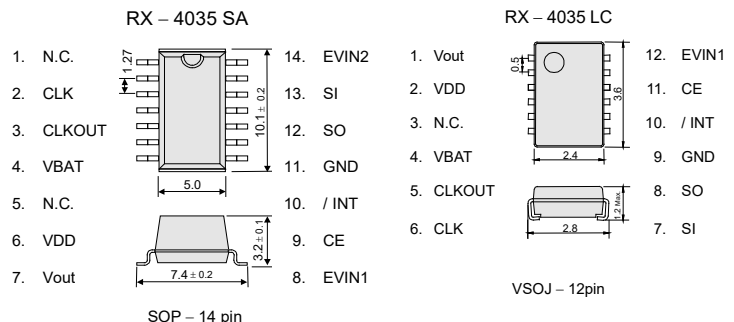
- **The event detection and Timestamp function**
 Dual event detection terminals.
 Selectable de-bounce time 35ms or 2s.
 Available event detection interrupt output.
- **Power switching functions.**
 - An external diode is unnecessary to have a reverse current prevention switch built-in in the VBAT side to connect a primary cell to.
 - When VDD is less than 2.4V, an internal source is switched to VBAT.
 - Note: When the supply from VBAT, SPI interface are disabled.
- **Alarm, Periodic interrupt, 32.768kHz clock output.**
 - Available monthly-alarm and weekly-alarm.
 - Interrupt period are selectable from 2Hz to Monthly.
 - CLKOUT outputs 32.768kHz clock powered by VDD.

Pin function

Signal Name	Input / Output	Function
VBAT	—	Power supply for backup.
Vout	Output	Switched power out. (maximum output current 20mA)
CE	Input	SPI chip enable.
CLK	Input	SPI serial clock.
SO	Output	SPI data out.
SI	Input	SPI data in.
GND	—	Ground
EVIN1	Input	Event detection input 1
EVIN2	Input	Event detection input 2
/ INT	Output	Interrupt out.
CLKOUT	Output	32.768kHz output. (CMOS. Can not inhibit.)
N.C.	—	Do not connect.
VDD	—	Main power supply.

Terminal connection / External dimensions

(Unit:mm)



The metal case inside of the molding compound may be exposed on the top or bottom of this product. This purely cosmetic and does not have any effect on quality, reliability or electrical specs.

Prohibition of use of glue after a mount of a product
 An LC package product cannot use glue and resin coating. When such a processing is necessary, please examine a CE package product.

Specifications (characteristics)

* Refer to application manual for details.

Recommended Operating Conditions

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Operating voltage	VACCESS	VDD	2.4	3.0	5.5	V
Time keeping voltage	VCLK	VBAT	1.0	3.0	5.5	V
Operating temperature	TOPR	—	-40	+25	+85	°C
Storage temperature	TSTG	—	-55	—	+125	°C

Frequency characteristics

Item	Symbol	Conditions	Rating	Unit
Frequency tolerance	$\Delta f / f$	Ta = +25°C VBAT = 3.0 V	B: 5 ± 23 *1) AA: 5 ± 5 *2) AC: 0 ± 5 *2)	$\times 10^{-6}$
Oscillation start-up time	tSTA	Ta = +25°C VDD = 3.0 V	1 Max.	s
Frequency / voltage characteristics	f / V	Ta = +25°C VDD = 2.4 V to 5.5 V	± 1 Max.	$\times 10^{-6}$

*1) Equivalent to ± 1 minute of monthly deviation (excluding offset.)
 *2) Equivalent to ± 13 seconds of monthly deviation (excluding offset.)

Current consumption characteristics

Ta = -40 °C to +85 °C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Current Consumption	IBAT	RX-4035SA VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open	-	350	1200	nA
		RX-4035LC VBAT = 3.0V, VDD = 0.0V CE = 0V, CLKOUT = open	-	400		
	IDD	VDD = 3.0V CE = 0V CLKOUT = open	-	1.40	2.50	μA

Power supply detection voltage

Ta = -40 °C to +85 °C

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Voltage of low battery detection	VLow	-	1.10	1.25	1.40	V
Power switching voltage (VDD to VBAT)	VD2B	+25 °C	2.328	2.40	2.472	V

► Explanation of the mark that are using it for the catalog

	<p>► Pb free.</p>
	<p>► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)</p>
	<p>► Designed for automotive general equipment.</p>
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